

European System-driven Semiconductor Initiative



Chip-to-System Acceleration

Detailed Overview – 30.01.2025

Industry players from all vertical markets are welcome to follow ESSI on
<https://www.linkedin.com/company/essi-think-tank/>

A web page is under construction at www.essi-eu.org

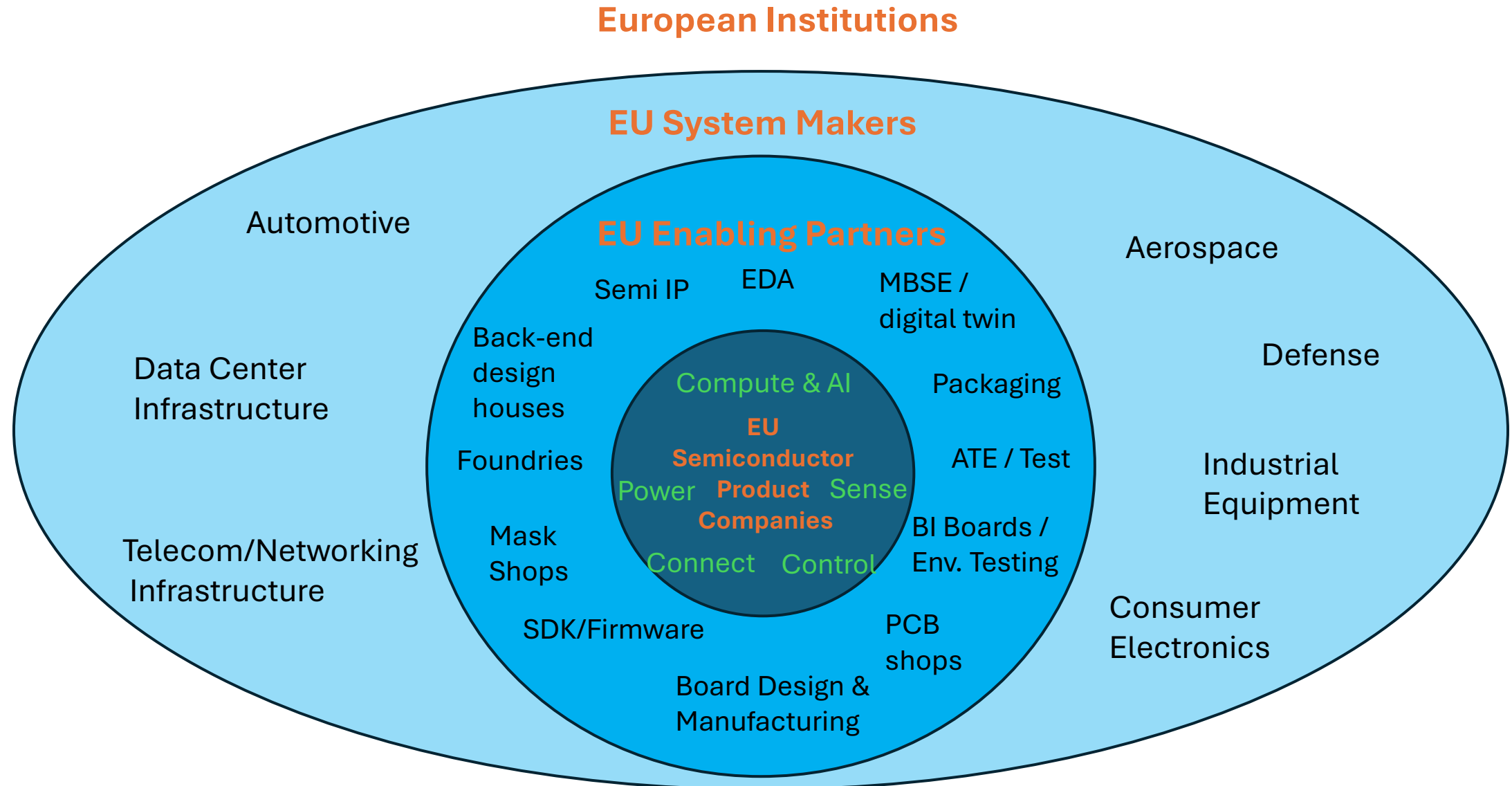
Scope & Genesis

The EU System-driven Semiconductor Initiative (ESSI): a think-tank
involving European industry-experienced members
from the semiconductor ecosystem and from system makers

Aims at identifying & promoting practical and impactful actions
to increase and accelerate the generation of economic value
enabled by European semiconductor products

Emerged from the observation that the European R&DI effort in
the semiconductor ecosystem could generate much more value faster,
if better aligned to and leveraged by EU system makers

Who is involved ?



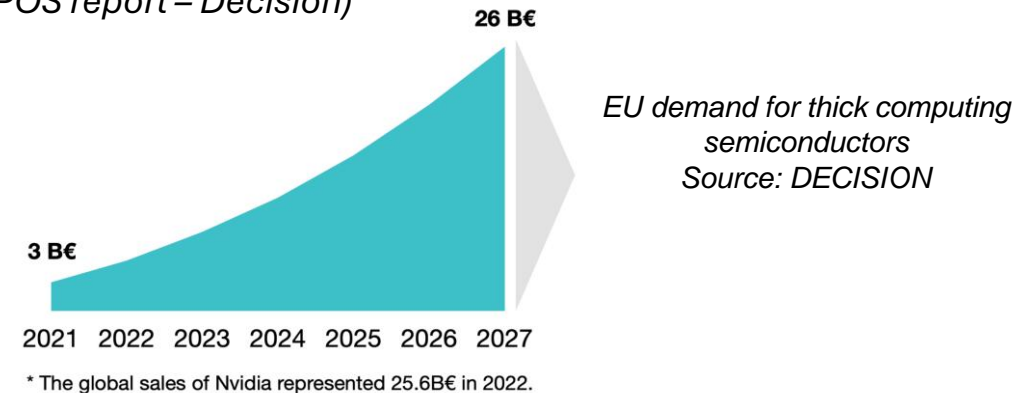
Multiple Reports Highlight the Urgency to Act

Coordination of research challenges and demand requirements ...will determine the EU's ability to...lead in selected industrial segments.

(The future of European competitiveness – Semiconductors - Mario Draghi Sept 2024)

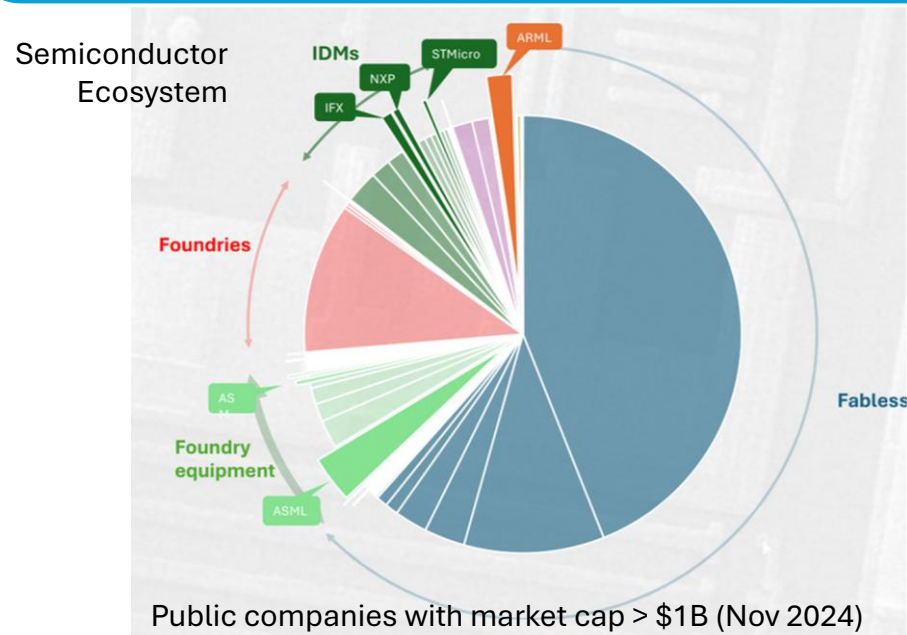
European system champions have a growing dependency on non-EU semiconductor products

e.g. the expected 26B€ demand in Europe for “thick computing semiconductor” will be mainly addressed by US fabless players.
(EPOS report – Decision)



Lack of fabless champion in Europe

(while this is the fastest and largest value-generation segment)



Many actions are taken to foster and fuel the EU innovation, R&D and manufacturing capability

But there are “blind spots” in the path towards the value creation Europe needs (revenues & equity)

Expected global impact of ESSI

Trigger a sustainable virtuous cycle

Strengthen (revive) the leadership of EU system makers

(automotive, aerospace, infrastructure, telecom & networking, industry 5.0, compute & data storage,)

Accelerate and multiply the value-generation

Across the entire semiconductor and electronics ecosystem.
Increase the EU semiconductor market share.

Motivate higher private investments

In EU semiconductor products companies and market-leading systems.

Make EU a good place to stay and grow

For semiconductor product startups/ mid-caps, protected from non-EU predators.

Provide EU with a stronger bargaining power

Assure economic security and supply within the global semiconductor ecosystem.

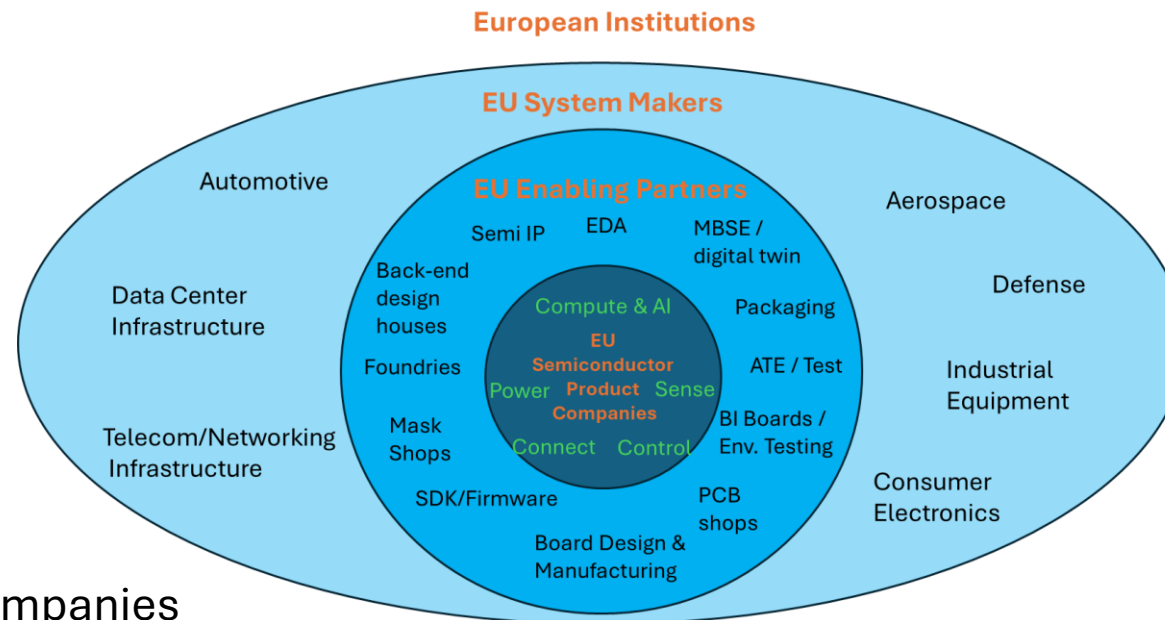


A stable business foundation
for EU wealth creation,
(re-)industrialization and jobs

ESSI Gives & Gets

Please refer to the ESSI Gives & Gets dedicated presentation

- For European Institutions
- For EU System Makers
- For EU Enabling Partners
- For EU Semiconductor Product Companies



Expected benefits

Expected benefits from the deployment of the ESSI-recommended actions

Expected involvement

Expected involvement within the scope of the ESSI think-tank and resulting actions

Call for actions: why we are here ?

Once you have reviewed this “ESSI Overview” and
the “ESSI Gives & Gets” presentations



Please let us know if you wish to express support to ESSI



You are welcome to get involved in the Think-tank activities
You can also provide a Letter of Support to strengthen the voice of ESSI
(example at the end of this presentation)

Key Anchor Points

EU semiconductor products could become a strong wealth engine for Europe, if focus is made on economic value generation, exploiting the well-fueled EU innovation pipeline.

→ Structuring and coordinating for highest EU economic impact is critical

EU electronics systems market is fragmented with no single player driving very large volume, limiting the attractiveness for semiconductor products companies.

→ Overcoming the ROI dilemma of EU semiconductor product companies is critical

Market deployment of systems is required to generate economic value from the investment in the semiconductor ecosystem (materials, equipment, fabs, EDA, product design)

→ Accelerating the development & deployment of EU systems is critical

EU System Makers are fiercely competing with each other and must be provided with solutions enabling their differentiation (chips, tools and infrastructure)

→ Chips & infrastructure for SW-defined and AI-driven systems are critical

It is up to the EU chip industry to provide attractive solutions. EU system makers focus on leading their industry. They select chips if enabling their leadership (cost, performance, TTM).

→ Building up a compelling system-aligned EU chip offering is critical

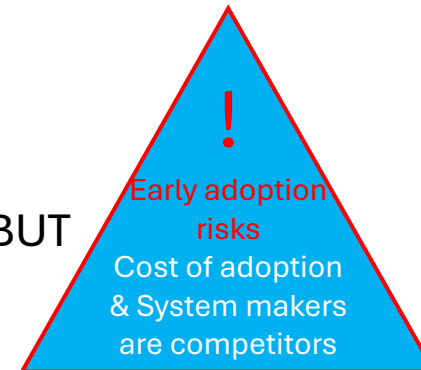
Private Investors are putting money where they feel comfortable wrt risks, potential & timeline. Europe shall become attractive for these 3 criteria for EU investors.

→ Structure to trigger EU private investments in EU semiconductor products is critical

Roadblocks slowing down the EU momentum

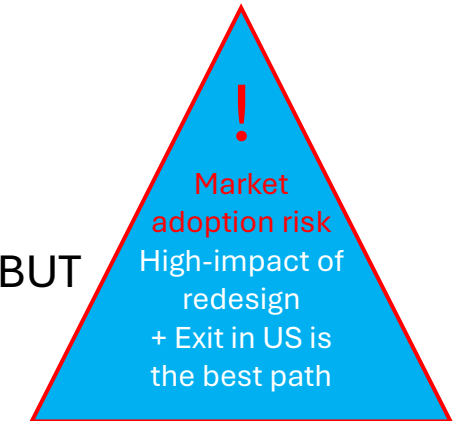
EU System Makers (OEMs) would like to leverage innovative semiconductor chips to enable system features, cost reduction and time-to-market.

BUT



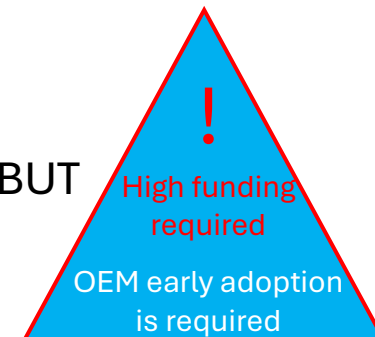
EU Private Investors (VC/PE/Family Offices/CVC) would like high-returns from innovative semiconductor chips.

BUT



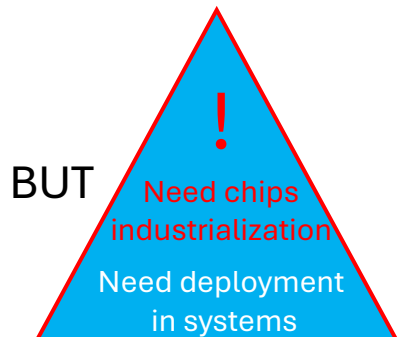
EU Semiconductor Product companies would like to accelerate the mass-deployment of their chips into various systems

BUT



EU Semiconductor support ecosystem (fabs/foundries, OSAT, EDA, design services,...) would like more chips to go to production to grow their business

BUT



Risks should be mitigated to unlock a virtuous cycle of value-generation!

Selecting innovative EU semiconductor products should be attractive for EU System Makers and EU Investors

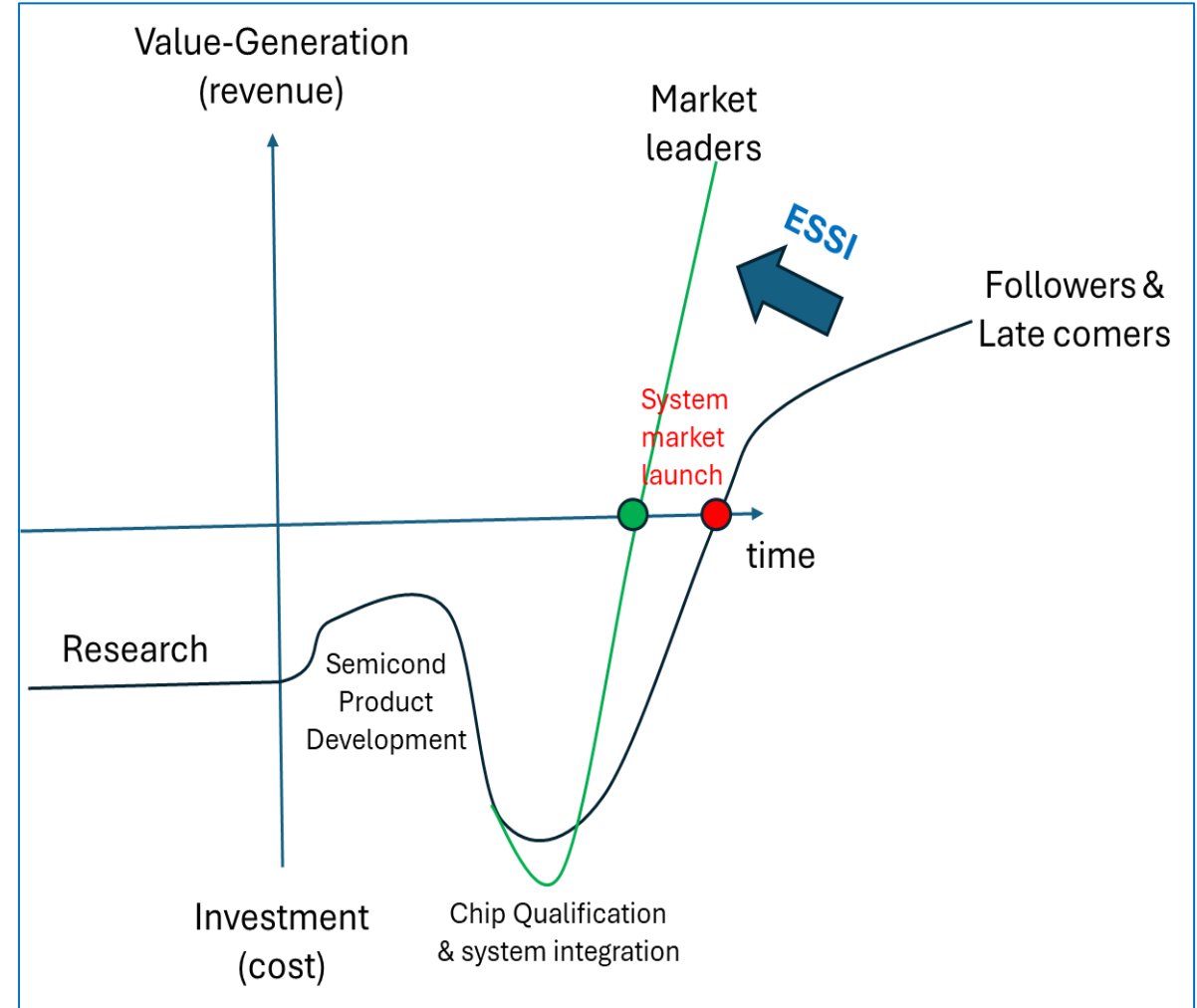
Why Foster EU System Makers Leadership ?

Because every successful market deployment of a leading EU electronics system has a high impact

- ✓ **Benefit for the entire ecosystem**
- ✓ **Broadest economic impact**
- ✓ **Global social/employment impact**
- ✓ **Bargaining power for supply**
- ✓ **Geopolitical weight**

Because it works !

- ✓ **USA, JPN, Korea, China**



What about the current EU actions ?

IPCEI

Important Projects of
Common Interest
> 90 B€

- 90+ % R&D. Many projects with overlap and no structured coordination.
- Ex: IPCEI CIS : 120 projects
IPCEI ME-CT : 68 projects
- Impact expected from dissemination and “spill-over”
- **No coordination towards coherent EU infrastructures**

Large potential of
deliverables to
tap into

EU Chips Act (2023-27)

- Chips JU (11 B€)
- EIC Accelerator (650M€)
- EIF (6.5B€ LP / 26.2B€ total)
- EIB (1248 B€)

- **EU Design Platform** limited to chips IP/prototyping
- **Pilots Lines** in R&D centers with no clear production path
- **Quantum Chips** without ecosystem & SW coordination
- **Competence Centers** mainly focused on R&D and skills
- **EIC fund:** 50% on R&D and 50% on startup acceleration
- **EIB** funding debt and series D/E

Large potential of
funding to accelerate
the value generation
(revenues / equity)

EU Associations

- INSIDE
- AENEAS
- EPoSS
- EU Semiconductor Alliance
- ESIA

- The existing Industry Associations are active in representing their members in front of the EU Commission, their scope is mainly focused on R&D.
- **Recommend to build a stronger link between the chips and the systems and software.**

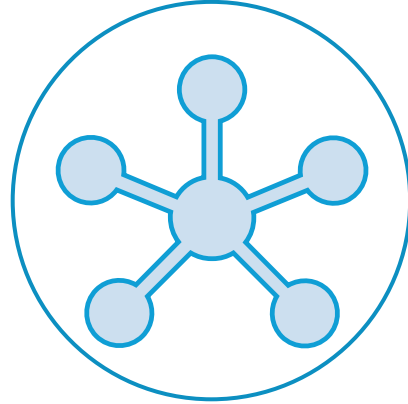
Large potential of
support to assure
coordination and
relay across the
industry

Four Foundational Recommendations



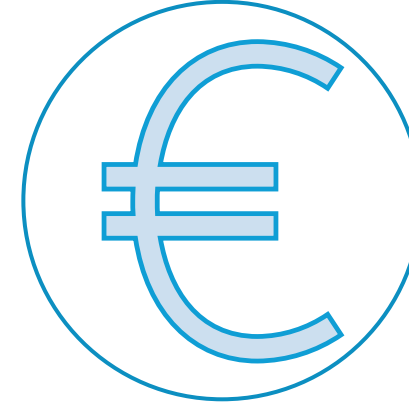
1. Gather and fund an industry-experienced team to facilitate chip-to-systems acceleration

- Focus on bridging semiconductor products with systems and closing gaps for fastest system launch
- Work with Inside, EPOSS, AENEAS, ChipJU, IPCEI... to leverage past & present R&D projects



2. Deploy strategic EU infrastructures to enable faster adoption of EU chips in systems

- System Design infrastructure (Extension of EU Design Platform)
- Advanced AI-as-a-Service Infrastructure
- Edge-to-Cloud continuum wireless infrastructure



3. Extend the EU R&D funding/calls to “chip-to-system acceleration” projects

- Acknowledge the high level of innovation in the tools and techniques developed to accelerate the qualification & industrialization of a chip.
- Automation engineering,



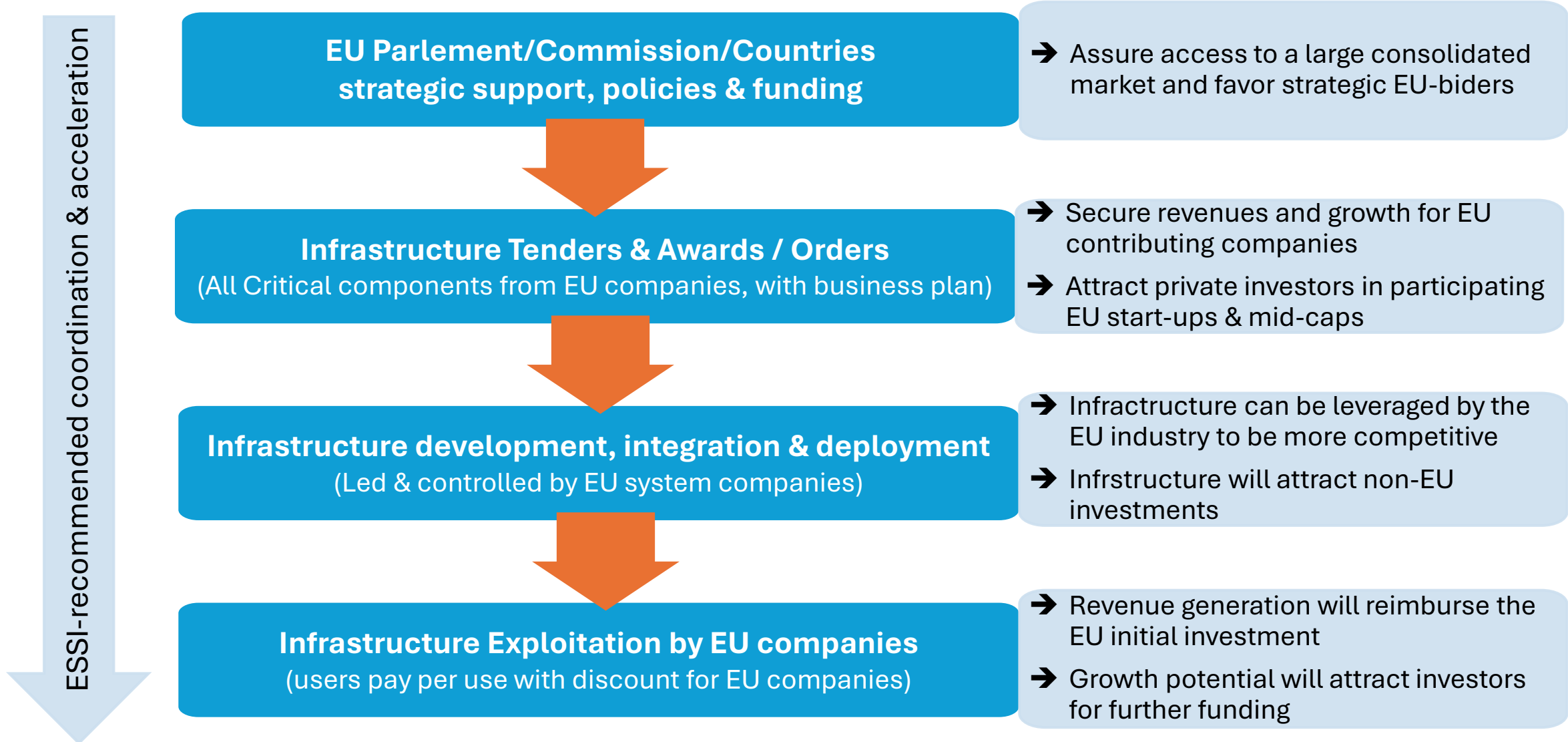
4. Establish an insurance fund to cover for some risks in early investment or adoption of semiconductor products

- Mutualized fund from countries hosting semiconductor product companies
- Conditioned on strict verification of the design

Chips ACT should be the catalyst environment for acceleration

The Power of EU Infrastructures

Apply the highway or railway model



How to express your support to ESSI ?

Get involved and provide feedback

- Follow the ESSI think-tank LinkedIn page (<https://www.linkedin.com/company/essi-think-tank/>)and the upcoming ESSI web site (www.essi-eu.org) and LinkedIn page when available
- Provide feedbacks and suggestions of improvement regarding the ESSI recommended actions
- Communicate about ESSI and expand awareness across your ecosystem
- Participate to the ESSI calls, activities and events
- Contribute to the construction of consortia for Chip-to-System Acceleration Projects

Send a Letter of Support

Example:

These letters will help the ESSI collective voice to be heard

“To whom it may concern.

On behalf of [Company, Organization], we wish to express our support to the European System-driven Semiconductor Initiative (ESSI). We adhere to the objectives towards a higher European industry competitiveness, and believe its recommendations can have a significant impact. We wish to participate to the ESSI think-tank and contribute to the European Chip-to-System Acceleration effort as it shapes.”

European System-driven Semiconductor Initiative



Chip-to-System Acceleration

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